



Data Sheet

Customer:

Part No:

CL-SF685UHYUYG-02

Sample No:

Description:

Item No:

Customer			
Check	Inspection	Approval	Date

■ Features :

- Compatible with automatic placement equipment
- Compatible with reflow solder process

■ Applications :

- Automotive_Telecommunication
- Indicators
- LCD Back-lights
- Illuminations

Absolute Maximum Ratings
(Ta=25°C)

Item	Symbol	Maximum	Unit
Peak Forward Current (1/10 Duty Cycle 0.1ms Pulse Width)	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Derating Linear From 25°C		0.4	mA/°C
Operating Temperature Range	T _{opr}	-30 to +80	°C
Storage Temperature Range	T _{stg}	-40 to +85	°C
Lead Soldering Temp.(1.6mm from body) for 5seconds		260	°C
Electrostatic discharge (ESD)	HBM	2000	V

Electrical / Optical Characteristics
(Ta=25°C)

Chip			Lens Appearance	Absolute Maximun Rating				Electro-optical Data (At 20mA)				Viewing Angle 2 θ 1/2 (deg)
Emitted Color	λ P (nm)	λ D (nm)		Ir (μ A)	△ λ (nm)	Pd (mW)	If (mA)	Vf(V)		Iv(mcd)		
								Typ.	Max.	Min.	Typ.	
Ultra High Yellow	589	591	Water Clear	10	20	72	30	1.9	2.4	115	145	120°
Ultra Yellow Green	575	574		10	20	72	30	1.9	2.4	45	72	

ISSUE	DIMENSION NO :	VERSION :	DATE :
		C	2016/03/31
	APPROVAL :	CHECK :	EDIT :

◆ The Luminous Intensity Grade of Ultra High Yellow Chip-LED Products

● Test Condition : @ 20mA

Range,mcd	Bin code
115/145	L1
145/180	L2
180/225	M1
225/285	M2

◆ Dominant Wavelength Grade of Ultra High Yellow Chip-LED Products

● I type @ 20mA

BIN	Range
0	585/588
1	588/591
2	591/594

◆ The Luminous Intensity Grade of Ultra Yellow Green Chip-LED Products

● Test Condition : @ 20mA

Range,mcd	Bin code
45/57	J1
57/72	J2
72/90	K1
90/115	K2

◆ Dominant Wavelength Grade of Ultra Yellow Green Chip-LED Products

● I type @ 20mA

BIN	Range
0	568/570
1	570/572
2	572/574

◆ Descriptions :

- The Chip-LED Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature application, etc.

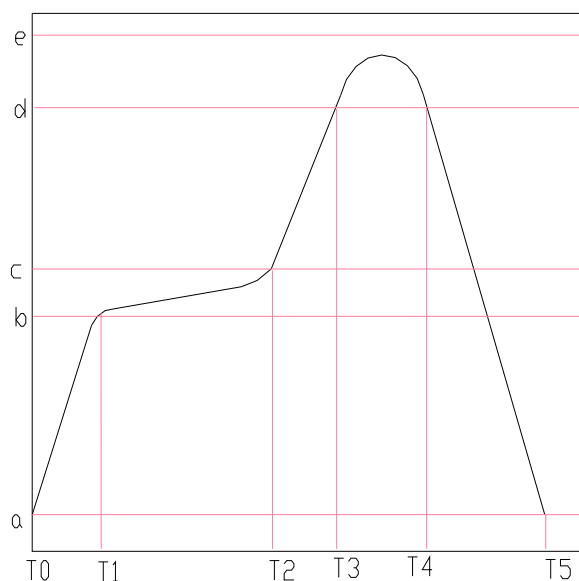
◆ Reliability Test Items And Conditions :

NO.	Item	Test Conditions	Test Hours / Cycle	Sample Q'ty	Ac / Re
1	Solder Heat	TEMP : 260°C±5°C	5 sec	36 pcs	0 / 1
2	Temperature Cycle	H : +100°C 30min. ∫ 5min. L : -40°C 30min.	50 cycle	36 pcs	0 / 1
3	Thermal Shock	H : +100°C 5min. ∫ 10sec L : -40°C 5min.	50 cycle	36 pcs	0 / 1
4	High Temperature Storage	TEMP : 100°C	1000 hrs	36 pcs	0 / 1
5	Low Temperature Storage	TEMP : -40°C	1000 hrs	36 pcs	0 / 1
6	DC Operating Life	I _F = 20mA	1000 hrs	36 pcs	0 / 1
7	High Temperature / High Humidity	85°C / 90~95%R.H.	1000 hrs	36 pcs	0 / 1

◆ Reflow Temp. / Time : :

Please refer to the following figure :

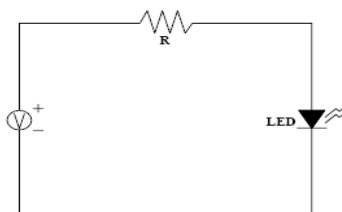
Temp.(°C)		Time(Sec)	
a	25	T0~T1	Max. 3°C/sec
b	150	T1~T2	90~130 sec
c	200	T2~T3	Max. 3°C/sec
d	220	T3~T4	Max. 30~50 sec
e	250		
		T4~T5	Max. -3°C/sec
Blet Speed		70~90 cm/min	



◆ Precautions For Use :

- Over – current – proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen)



- Storage

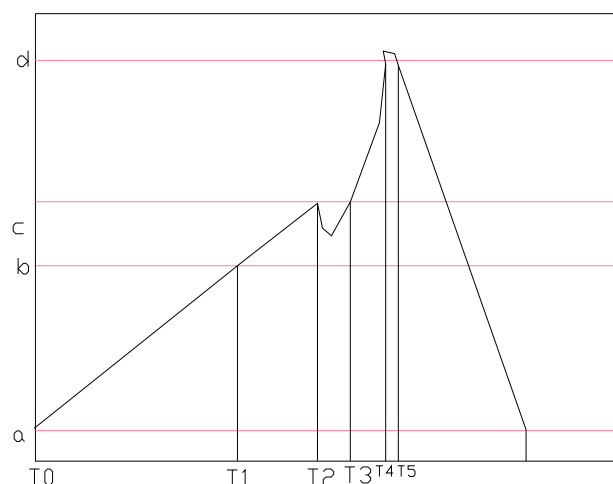
1. The operation of temperature and R.H. are : $5^{\circ}\text{C} \sim 30^{\circ}\text{C}$, R.H.60% Max..
2. Once the package is opened, the products should be used within 72 hrs. Otherwise, they should be kept in a dampproof box with desiccating regent. Considering the tape life, we suggest our customers to use our products within 1 year (from production date) .
3. It's recommended to bake before soldering when the package is unsealed after 72 hrs. The condition is : $80^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 24hrs.

◆ Soldering Iron :

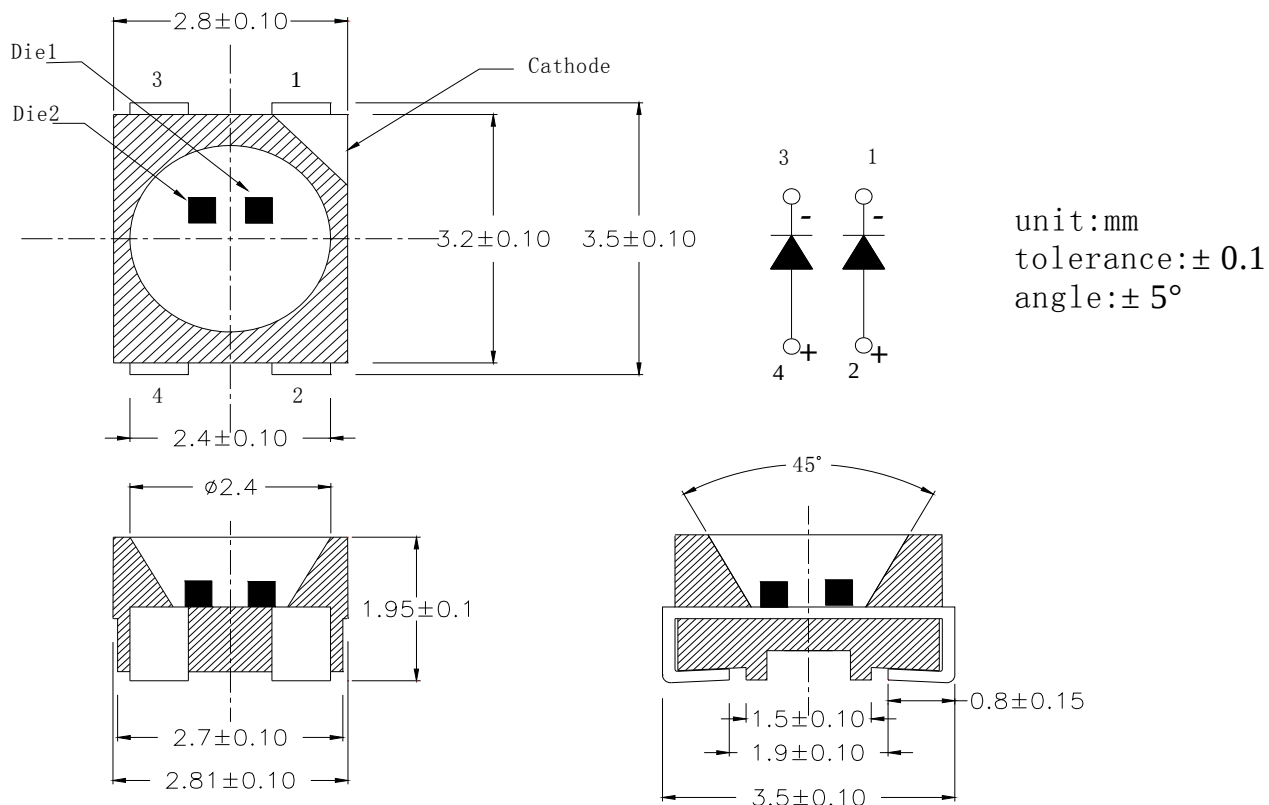
- Temperature at tip of iron : 300°C Max. (25W Max.)
- Soldering time : $5 \pm 1\text{sec}$.

◆ Wave Soldering Temp. / Time :

Temp.($^{\circ}\text{C}$)		Time(Sec)	
a	25	T1~T2	60 ± 20
b	130 ± 10	T2~T3	
c	185	T3~T6	
d	250 ± 3	T4~T5	3 ± 2

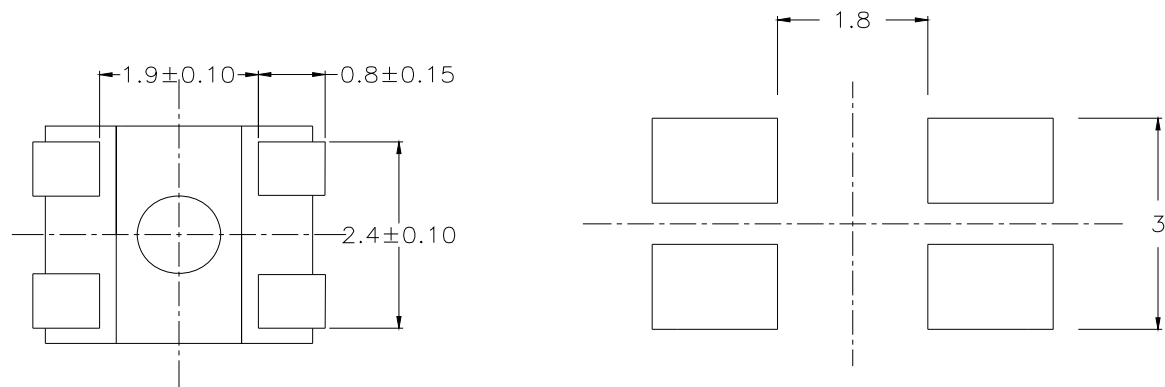


◆ Package Dimensions of Device

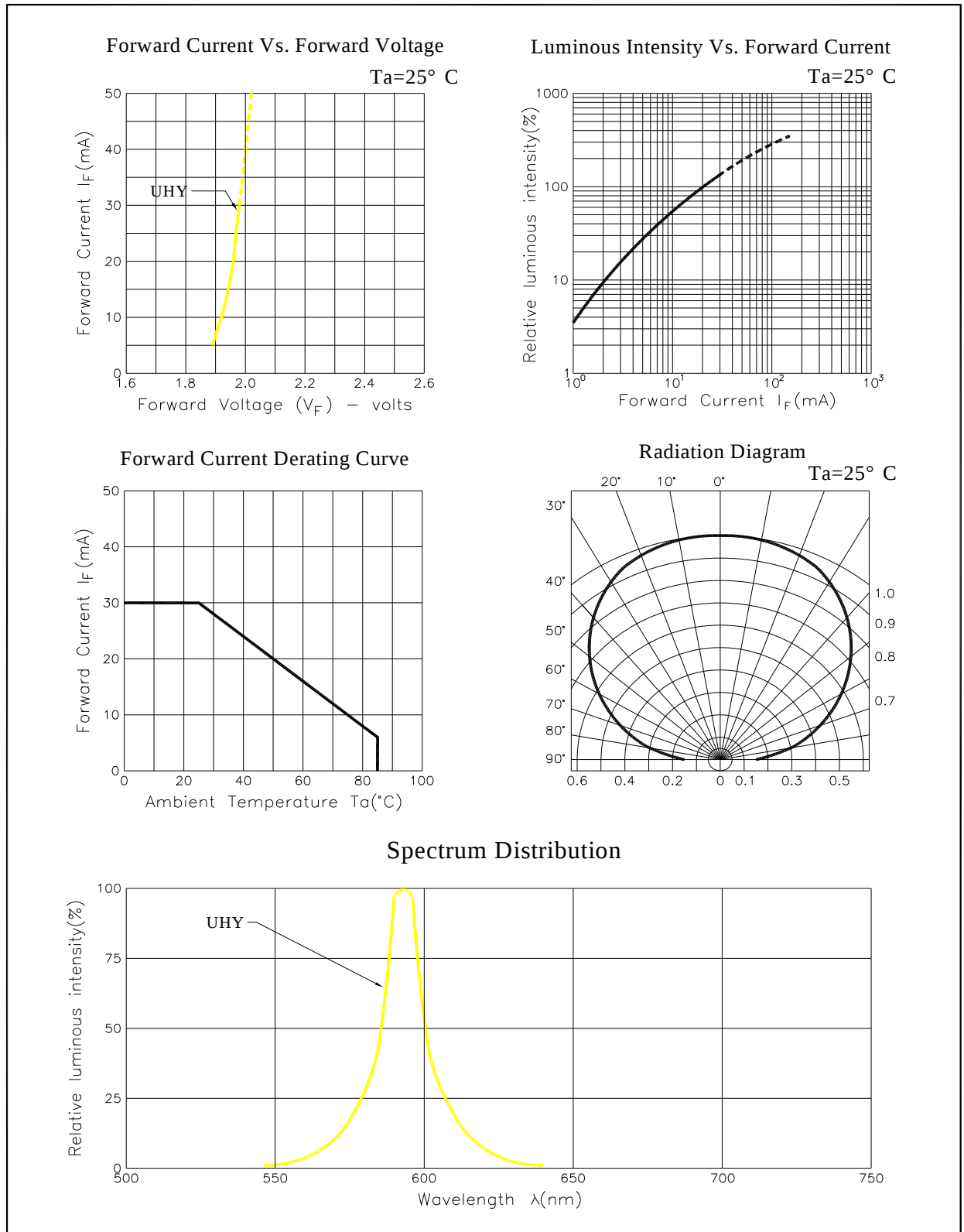


1. Soldering terminal may shift in x, y direction.
2. Polarity referring onto the cathode mark is reversed on the UR/HR/SR

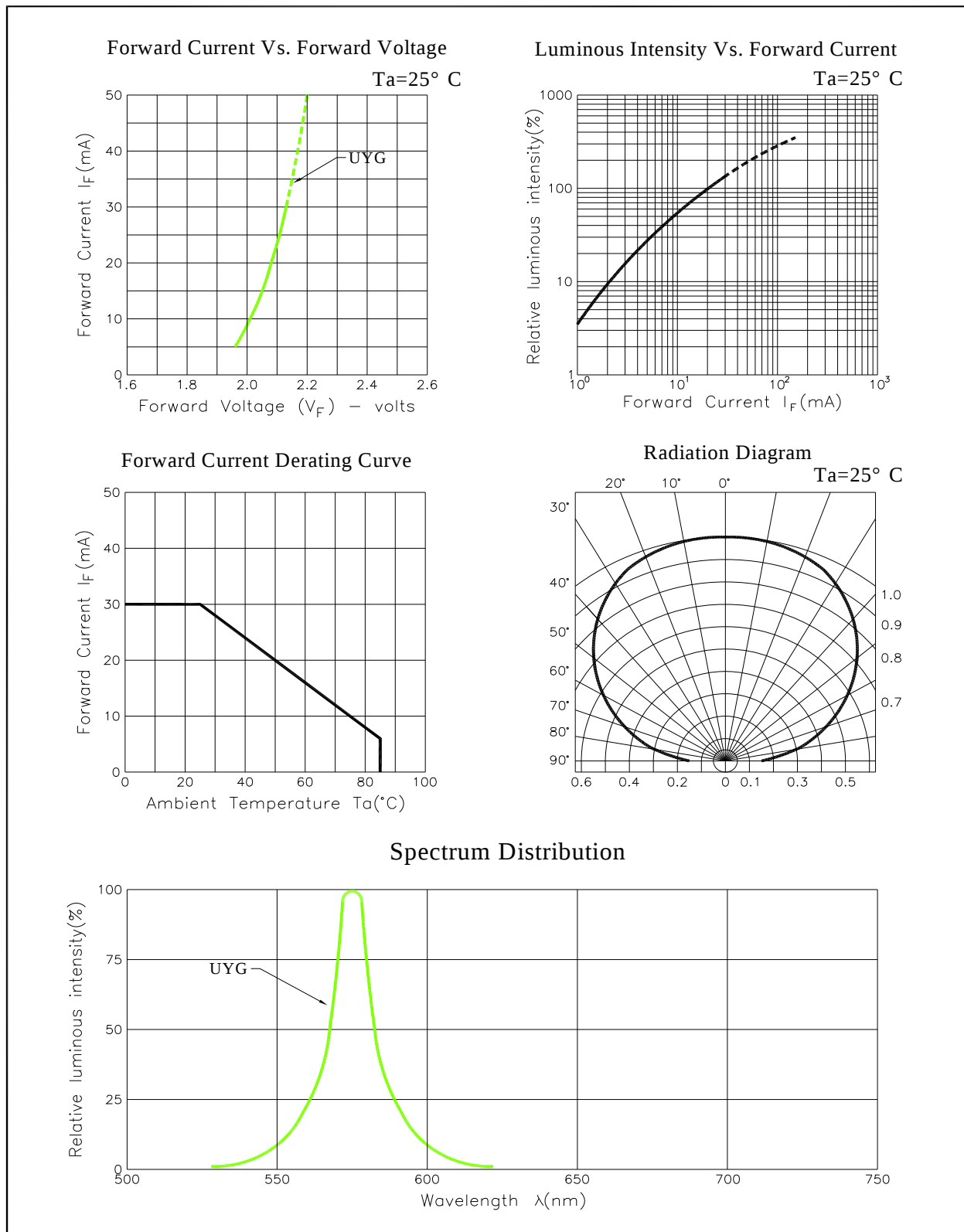
◆ Recommended Soldering Pad Dimensions



◆ **Typical Electro-Optical Characteristic Curves:**

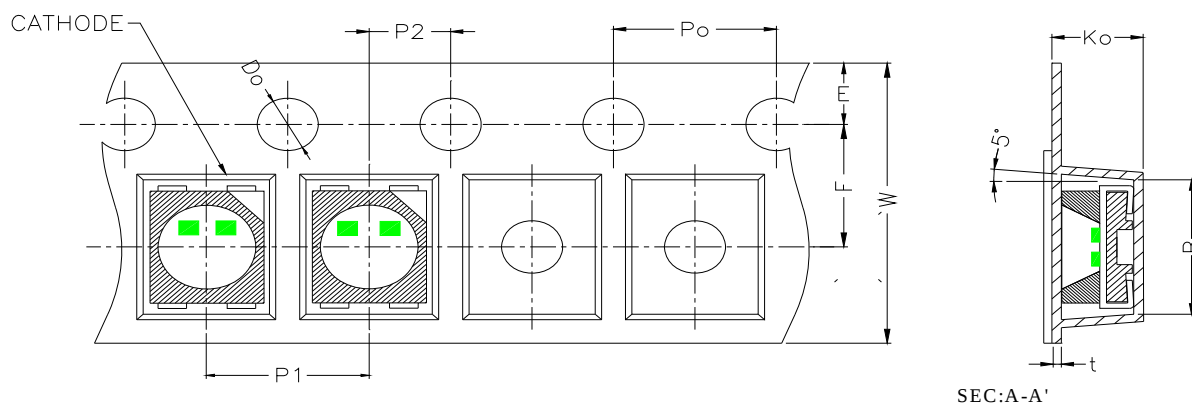


◆ **Typical Electro-Optical Characteristic Curves:**



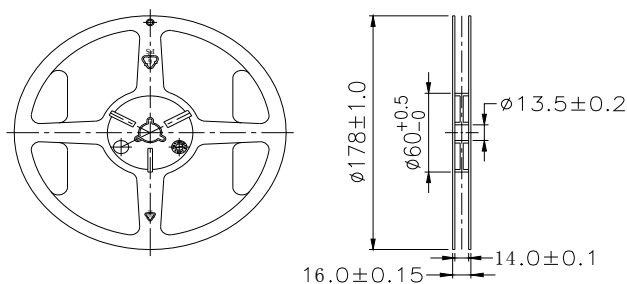
◆ Tape Specification : 2000pcs Per Reel

Packing Size													
Item	W	P1	E	F	Do	D1	Po	10Po	P2	Ao	Bo	Ko	t
Spec.	8.0	4.00	1.75	5.50	1.5	0.5	4.00	40.00	2.00	3.10	3.84	2.24	0.23
Tolerance	±0.20	±0.10	±0.10	±0.05	+0.10 -0.00	±0.05	±0.05	±0.20	±0.05	±0.10	±0.10	±0.10	±0.05



Unit:mm

◆ Package Dimensions of Reel



◆ Label explanation

Product No:CL-SF685UHYUYG	
Lot No: XXXXXXXXX	
Q'ty: XXXX	PCS
Q.C: XXXXXX	BIN
Date:XXXX.XX.XX	